



PRINTER FULL AUTOMATIC SOLDER PAST	SPECIFICATIONS
Basic Board Size (XY)	Max 450mm*350mm/ Min 50mmx50mm
PCB Thickness	0.6mm ~ 14mm
Warpage	Max. PCB Diagonal line 1%
Maximum Board Weight	10Kg
Transfer Speed	1500mm/s (Max)
Transfer Mode	One Phase Rail
Template Frame Size	370mm x 470mm~737mm x 737mm
Maximum Printing Area	450mm x 350mm
Squeegee Type	Stee/Glue/(Angle 45°/55°/60° matching the printing process)
Demoulding Lenght	0.2mm~12mm
Platform Adjustment Range	X,Y +/-7.0mm, θ +/- 2.0°
Camera System	Independent Camera upwards/ downwards/ Imaging Vision System
Repetition Precision of Image Calibration	+/-12.5 μ m (+/- 0.0005") @6 σ , Cp $\geq$ 2.0
Cycle Time	< 7s
Power Requirements	AC220V $\pm$ 10%, 50/60Hz 15A
Dimension	L 1140mm x W 1400mm x H 1480mm
Weight	1000Kg